

Features

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant(Note 1) ("P" Suffix Designates Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- · Low Switching Losses and High Efficiency
- Ultrafast and Ultrasoft Recovery
- Near Zero Temperature Coefficient
- Planar Structure Die

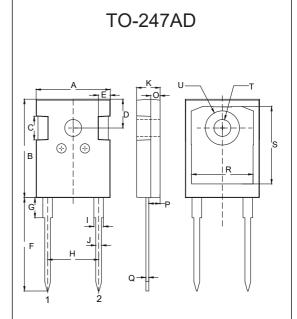
50 Amp Ultrafast Recovery Rectifier 1200 Volts

Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V_{RRM}			
Working Peak Reverse Voltage	V _{RWM}	1200	V	
DC Blocking Voltage	V _R			
RMS Reverse Voltage	V _{RMS}	840	V	
Average Rectified Forward Current	I _{F(AV)}	50	Α	
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave	I _{FSM}	400	А	
Current Squared Time @ 1ms≤t≤8.3ms	l ² t	664	A ² s	

Marking Diagram	Internal Structure			
MCC MCC MUZ50120P H Marking Code: MURZ50120P	PIN 1 • CASE			

Note: 1. High Temperature Solder Exemption Applied, See EU Directive Annex 7a.



DIM INCHES		M	IM	NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.602	0.642	15.30	16.30	
В	0.799	0.839	20.30	21.30	
С	0.189	0.205	4.80	5.20	
D	0.2	0.242		15	BSC.
Е	0.091	0.106	2.30	2.70	
F	0.768	0.807	19.50	20.50	
G		0.189		4.80	
Н	0.428		10.88		BSC.
I	0.075	0.087	1.91	2.21	
J	0.044	0.054	1.11	1.36	
K	0.189	0.205	4.80	5.20	
0	0.073	0.085	1.85	2.15	
Р	0.087	0.103	2.21	2.61	
Q	0.020	0.030	0.51	0.75	
R	0.512	0.535	13.00	13.60	
S	0.640	0.663	16.25	16.85	
Т	0.134	0.150	3.40	3.80	Ф
U		0.287		7.30	Ф



Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _J	Operating Junction Temperature Range		-55		150	°C
T _{stg}	Storage Temperature Range		-55		150	°C
Rth _(J-C)	Thermal Resistance from Junction to Case			0.65		°C/W
Rth _(J-A)	Thermal Resistance from Junction to Ambient	Free in Air		38		°C/W

Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _F	I _F =50A;T _J =25°C		1.65	1.85	V
		I _F =50A;T _J =125°C		1.64		V
Reverse Current	I _R	V _R =1200V;T _J =25°C			10	μA
		V _R =1200V;T _J =125°C			2	mA
Junction Capacitance	CJ	V _R =4V;f=1MHz;T _J =25°C		180		pF

Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
		I _F =0.5A; I _R =1.0A;I _{RR} =0.25A;T _J =25°C			150	200	
		I _F =1A; dI _F /dt=-200A/μs; V _R =30V; T _J =25°C			50		
Reverse Recovery Time	t _{rr}		T _J =25°C		265		ns
			T _J =125°C		420		
Dools Doorsons Comment		l _F =50A; dl _F /dt=-200A/μs;	T _J =25°C		23.9		Α
Peak Recovery Current	I _{RRM}	V _R =200V	T _J =125°C		32.6		A
Reverse Recovery Charge Q _{rr}	0		T _J =25°C		2728		nC
	Q _{rr}	T _J =12			5945		IIC



Curve Characteristics

25

50

0

60 Soward Criment (A) 20 Soward Criment (A) 30 Soward Criment (A) 10 Soward (A) 10

Fig. 1 - Forward Current Derating Curve

Fig. 3 - Typical Forward Characteristics

Case Temperature (°C)

100

125

150

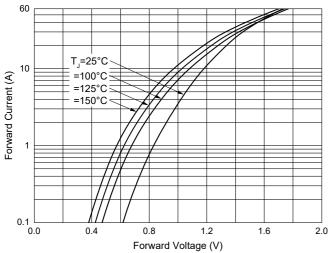


Fig. 5 - Typical Capacitance Characteristics

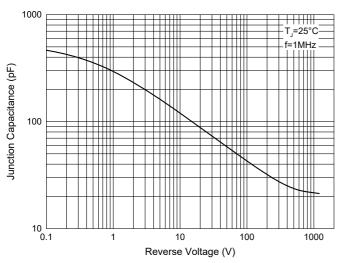


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

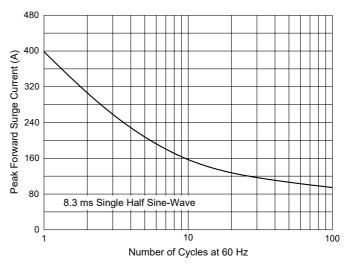


Fig. 4 - Typical Reverse Leakage Characteristics

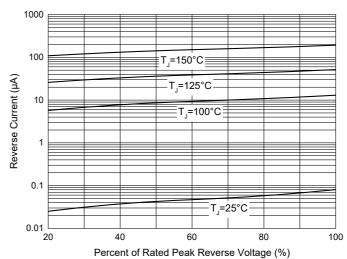
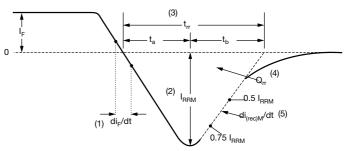


Fig. 6 - Reverse Recovery Waveform and Definitions



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $t_{\rm fr}$ reverse recovery time measured from zero crossing point of negative going $I_{\rm F}$ to point where a line passing through 0.75 $I_{\rm RRM}$ and 0.50 $I_{\rm RRM}$ extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}



Ordering Information

Device	Packing
MURZ50120P-BP	Bulk:30pcs/Tube,360pcs/Box,1.8Kpcs/Carton

Note: Adding "-HF" Suffix For Halogen Free, eg. MURZ50120P-BP-HF

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